

DOCKET NO: 213480US0

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :  
SEI TSUNODA, ET AL. : EXAMINER: VIJAYAKUMAR, K.M.  
SERIAL NO: 09/942,626 :  
FILED: AUGUST 31, 2001 : GROUP ART UNIT: 1751  
FOR: LOW DIELECTRIC CONSTANT :  
MATERIAL HAVING THERMAL  
RESISTANCE, INSULATION FILM  
BETWEEN SEMICONDUCTOR LAYERS  
USING THE SAME, AND  
SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 CFR 1.312

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Please amend the above-identified application pursuant to 37 CFR 1.312 as follows.

**Amendments to the Claims** are reflected in the listing of claims which begins on  
page 2 of this paper.

**Discussion of the Amendment** begins on page 7 of this paper.

**Remarks** begin on page 8 of this paper.

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